# Nonvolatile DACPOT™ Electronic Potentiometer With Debounced Push Button Interface

#### **FEATURES**

**Digitally Controlled Electronic Potentiometer** 

- 7-Bit Digital-to-Analog Converter (DAC)
  - Independent Reference Inputs
  - Differential Non-Linearity of ±0.5LSB max
  - Integral Non-Linearity of ±1LSB max
- VOUT Value in EEPROM for Power-On Recall
  - Equivalent to 128-Step Potentiometer
- Unity Gain Op Amp Drives up to 1mA
- Simple Trimming Adjustment
  - Debounced Pushbutton Interface
- Low Noise Operation
- "Clickless" Transitions between DAC Steps
- No Mechanical Wear-out Problem
  - 1.000.000 Stores (typical)
  - 100 Year Data Retention
- Operation from 2.7V to 5.5V Supply
- Low Power: 1mW max at 5V

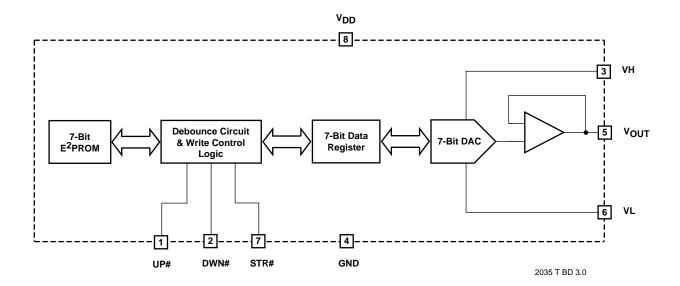
#### **OVERVIEW**

The SMP9517 DACPOT trimmer is an 7-bit nonvolatile DAC designed to replace mechanical potentiometers. The SMP9517 includes a unity-gain amplifier to buffer the DAC output and enables  $V_{\text{OUT}}$  to swing from rail to rail. The DACPOT trimmer operates over a supply voltage range of 2.7V to 5.5V.

The SMP9517's simple pushbutton input provides an ideal interface for operator adjusted equipment. This interface allows for quick and easy adjustment of even the most sophisticated systems.

The SMP9517 is a pin-compatible performance upgrade for other industry nonvolatile potentiometers. For higher resolution applications the pin-compatible S9518 provides 256 steps with the same pushbutton interface. Both the SMP9517 and the S9518 provide 'clickless' transitions of V<sub>OUT</sub>.

#### **FUNCTIONAL BLOCK DIAGRAM**





#### PIN NAMES

Symbol	Description		
UP#	PB input, moves $V_{OUT}$ toward $V_{H}$ input		
DWN#	PB input, moves $V_{\text{OUT}}$ toward $V_{\text{L}}$ input		
V <sub>H</sub>	$V_{REF}$ high		
GND	Ground		
V <sub>out</sub>	Trimmed voltage output		
et4U.com <b>V</b> L	$V_{REF}$ low		
STR#	Store input, providing a control input to initiate a store operation		
V <sub>DD</sub>	Supply voltage (2.7V to 5.5V)		

2035 Table01 3.0

# **Analog Section**

The SMP9517 is an 7-bit, voltage output digital-to-analog converter (DAC). The DAC consists of a resistor network that converts 7-bit digital values into equivalent analog output voltages in proportion to the applied reference voltage.

### **Reference Inputs**

The voltage differential between the  $V_L$  and  $V_H$  inputs sets the full-scale output voltage range.  $V_L$  must be equal to or greater than ground (a positive voltage).  $V_H$  must be greater than  $V_L$  and less than or equal to  $V_{DD}$ . See specifications for guaranteed operating limits.

#### **Output Buffer Amplifier**

The voltage output is from a precision unity-gain follower that provides a rail-to-rail output swing.

# **Digital Interface**

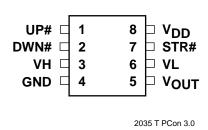
The interface provides simple pushbutton control of an up/down counter that drives the DAC. The DAC output is a ratiometric voltage output.

**UP#** is an active low pushbutton input. An internal pull-up resistor, with nominal value of  $50k\Omega$ , eliminates an external resistor. A 30ms debounce period is included in the input timing to prevent multiple pulsing of the counter. Either a switch closure to ground or a low logic level will, after the debounce time, change the potentiometer tap position. UP# moves the output voltage towards the V<sub>H</sub> reference input.

If the UP# pushbutton is kept depressed the counter will continue to increment at the rate of one count every 250ms for one second. After one second the counter increments faster, one count every 50ms, until the pushbutton is released. Changes to the DAC output using the UP# input do not alter the data stored in EEPROM.

#### **PINOUT**

#### 8-Pin SOIC



**DWN#** is an active low pushbutton input that decrements the counter and moves the potentiometer output voltage towards the  $V_L$  reference input. The DWN# control input also includes an internal  $50k\Omega$  pull-up resistor and a 30ms debounce period to prevent multiple pulsing. A low logic level will also change the potentiometer tap position after the debounce period.

If the DWN# pushbutton is kept depressed the counter continues to decrement at the rate of one count every 250ms for one second. After one second the counter decrements at one count every 50ms until the pushbutton is released. Changes to the DAC output using the DWN# input do not alter the data stored in EEPROM.

**STR#** This input can be used in two ways:

- If the input is tied low, then AUTOSTORE is enabled. When V<sub>DD</sub> powers down, an automatic store cycle takes place that updates the nonvolatile EEPROM memory.
- 2) STR# is an active low pushbutton input that also updates the nonvolatile memory. The input is debounced but does not have an internal pull-up resistor. For every valid push the SMP9517 will store the current potentiometer position to EEPROM.



# **DEVICE OPERATION**

There are five main blocks to the SMP9517: an 7-bit EEPROM memory; input debounce circuits, control logic, and 7-bit counter; 7-bit data register; decode section and resistor ladder (DAC); and the buffer amplifier.

The input control section operates just like an up/down counter. The output of this counter is fed to the data register and then decoded to activate one of 127 electronic switches connected to the resistor ladder. The ladder is comprised of 128 resistors of equal value connected in series. At the bottom of the ladder and at the junctions of the resistors there are electronic switches that transfer the voltage at each point to the buffer amplifier and then to the output.

The SMP9517 is designed to interface directly to two pushbutton switches that effectively move the potentiometer wiper up or down. The UP# and DWN# inputs, respectively, increment or decrement the 7-bit counter. The data input to the DAC is decoded to select one of the 128 wiper positions along the resistive ladder. The wiper increment input UP# and the wiper decrement input DWN# are connected to internal pull-ups so that they normally remain high. When pulled low by an external pushbutton switch or a logic low level input, the wiper will be switched to the next adjacent tap position. Internal debounce circuitry prevents inadvertent switching of the wiper position if UP# or DWN# remain low for less than 30ms (typical).

Each of the buttons can be pushed either once for a single increment/decrement or held low continuously for multiple increments/decrements. The number of increments/decrements of the wiper position depends on how long the

button is pushed. When making a continuous push, after the first second, the increment/decrement speed increases. For the first second the device will be in the slow scan mode. Then, if the button is held for longer than one second, the device will go into the fast scan mode. As soon as the button is released the SMP9517 will return to a standby condition.

The DAC, whether set to  $00_{\text{HEX}}$  or FF<sub>HEX</sub>, acts like its mechanical equivalent and does not move beyond the last position. That is, the counter does not wrap around when clocked up to FF<sub>HEX</sub> or down to  $00_{\text{HEX}}$ .

#### **AUTOSTORE**

The value of the counter is stored in EEPROM memory whenever the chip senses a power-down of  $V_{DD}$  while STR# is enabled (held low). When power is restored the contents of the memory are recalled and the counter reset to the last value stored. If AUTOSTORE is to be implemented, STR# is typically hard wired to GND. If STR# is held high during power-up and then taken low the wiper will not respond to the UP# or DWN# inputs until STR# is brought high and the store is complete. See Figure 1.

#### Manual (Pushbutton) Store

When STR# is not enabled (held high) a pushbutton switch may be used to pull STR# low and released to perform a manual store of the wiper position in EEPROM memory. See Figure 2.

#### Effect of V<sub>DD</sub> Removal

The resistor ladder, connected between  $V_H$  and  $V_L$ , does not change value when  $V_{DD}$  is removed. However, the buffer amplifier no longer functions, and consequently a high impedance appears at the  $V_{OUT}$  pin.

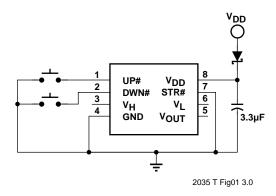


Figure 1: Typical circuit with STR store pin used in AUTOSTORE mode

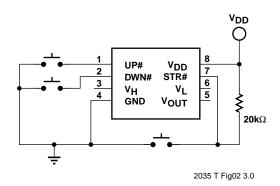


Figure 2: Typical circuit with STR store pin controlled by push button switch



### **ABSOLUTE MAXIMUM RATINGS**

Temperature Under Bias -55°C to 125°C Storage Temperature -65°C to 150°C

Voltage on pins with reference to GND:

 $\begin{array}{lll} \mbox{Analog Inputs} & -0.5\mbox{V to V}_{\mbox{DD}} + 0.5\mbox{V} \\ \mbox{Digital Inputs} & -0.5\mbox{V to V}_{\mbox{DD}} + 0.5\mbox{V} \\ \mbox{Analog Outputs} & -0.5\mbox{V to V}_{\mbox{DD}} + 0.5\mbox{V} \end{array}$ 

Digital Outputs -0.5V to V<sub>DD</sub>+0.5V

Lead Solder Temperature (10s) 300°C

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#### **COMMENT**

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions outside those listed in the operation sections of this specification is not implied. Exposure to any absolute maximum rating for extended periods may affect device performance and reliability.

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#### RECOMMENDED OPERATING CONDITIONS

Condition	Min.	Max.
Temperature	–40°C	85°C
$V_{DD}$	2.7V	5.5V

2035 Table02 3.0



# DAC DC ELECTRICAL CHARACTERISTICS

 $V_{DD} = 2.7V$  to 5.5V,  $V_{REFH} = V_{DD}$ ,  $V_{REFL} = 0V$ ,  $T_A = -40$ °C to 85°C, unless specified otherwise

	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Accuracy	INL	Integral Non-Linearity	$I_{LOAD} = 100\mu A$ ,		0.5	±1	LSB
	DNL	Differential Non-Linearity	I <sub>LOAD</sub> = 100μA, Guaranteed but not tested		0.1	±0.5	LSB
References	V <sub>H</sub>	V <sub>REFH</sub> Input Voltage		V <sub>REFL</sub>		$V_{DD}$	V
	VL	V <sub>REFL</sub> Input Voltage		Gnd		VREFH	V
t4U.com	R <sub>IN</sub>	V <sub>REFH</sub> to V <sub>REFL</sub> Resistance			38k		Ω
	TCR <sub>IN</sub>	Temperature Coefficient of R <sub>IN</sub>	VREFH to VREFL		600		ppm/°C
Analog	GEFS	Full-Scale Gain Error	DATA = FF <sub>HEX</sub>			±1	LSB
Output	VoutZS	Zero-Scale Output Voltage	DATA = 00 <sub>HEX</sub>	0		20	mV
	TCV <sub>OUT</sub>	V <sub>OUT</sub> Temperature Coefficient	$V_{DD} = 5$ , $I_{LOAD} = 50\mu A$ , $V_{REFH} = 5V$ , $V_{REFL} = 0V$ Guaranteed but not tested			50	μV/°C
	IL	Amplifier Output Load Current		-200		1000	μA
	R <sub>OUT</sub>	Amplifier Output Resistance	$I_{LOAD} = 100 \mu A  V_{DD} = 5 V$ $V_{DD} = 3 V$		10 20		Ω Ω
	PSRR	Power Supply Rejection	I <sub>LOAD</sub> = 10μA			1	LSB/V
	e <sub>N</sub>	Amplifier Output Noise	$f = 1kHz, V_{DD} = 5V$		90		nV/√H <sub>Z</sub>
	THD	Total Harmonic Distortion	V <sub>IN</sub> = 1V <sub>RMS</sub> , f = 1kHz		0.08		%
	BW	Bandwidth -3dB	V <sub>IN</sub> = 100mV <sub>RMS</sub>		300		kHz

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# **RELIABILITY CHARACTERISTICS**

Symbol	Parameter	Min.	Max.	Unit
$V_{\sf ZAP}$	ESD susceptibility	2000		V
I <sub>LTH</sub>	Latch up	100		mA
T <sub>DR</sub>	Data retentiaon	100		Years
N <sub>END</sub>	Endurance	1,000,000		Stores

2035 Table03 3.0

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# DC ELECTRICAL CHARACTERISTICS V<sub>DD</sub> = 2.7V to 5.5V, V<sub>H</sub> = V<sub>DD</sub>, V<sub>L</sub> = 0V, Unless otherwise

specified <b>Symbol</b>	Parameter	Conditions	Min	Max	Units
I <sub>DD</sub>	Supply Current during store (Note 1)	STR# =		1.2	mA
I <sub>SB</sub>	Supply Standby Current			200	μΑ
I <sub>IH</sub>	Input Leakage Current	$V_{IN} = V_{DD}$		10	μΑ
I <sub>IL</sub>	Input Leakage Current (Note 2)	V <sub>IN</sub> = 0V		-100	μΑ
V <sub>IH</sub>	High Level Input Voltage		2	V <sub>DD</sub>	V
VIL	Low Level Input Voltage		0	0.8	V

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#### Notes:

- 1. I<sub>DD</sub> is the supply current drawn while the EEPROM is being updated. I<sub>DD</sub> does not include the current that flows through the Reference resistor chain.
- 2. UP# and DWN# have internal pull-up resistors of approximately  $50k\Omega$ . When the input is pulled to ground the resulting output current will be  $V_{DD}/50k\acute{y}$ .

# AC OPERATING CHARACTERISTICS V<sub>DD</sub> = 4.5V to 5.5V

		Limits			
Symbol	Parameter	Min.	Тур.	Max.	Units
f <sub>GAP</sub>	Time Between Two Separate Push Button Events	0			μs
t <sub>DB</sub>	Debounce Time		30	60	ms
ts slow	After Debounce to Wiper Change on a Slow Mode	100	250	375	ms
ts fast	Wiper Change on a Fast Mode	25	50	75	ms
t <sub>PU</sub>	Power-Up to Wiper Stable			500	μs
t <sub>R</sub> V <sub>DD</sub>	V <sub>DD</sub> Power-Up Rate	0.2		50	mV/μs
t <sub>ASTO</sub>	AUTOSTORE Cycle Time (Note 3)	4	2		ms
Vasth	AUTOSTORE Threshold Voltage (Note 3)	4.6		5.5	V
tasend	AUTOSTORE Cycle End Voltage		3.5		V

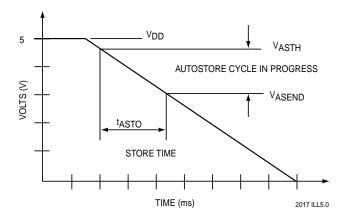
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#### Notes:

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3. t<sub>ASTO</sub> and V<sub>ASTH</sub> are characterized and periodically sampled, but not 100% tested.





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#### Notes:

 $V_{ASTH}$  = AUTOSTORE threshold voltage  $V_{ASEND}$  = AUTOSTORE cycle end voltage  $t_{ASTO}$  = AUTOSTORE cycle time

### FIGURE 3. AUTOSTORE CYCLE TIMING DIAGRAM

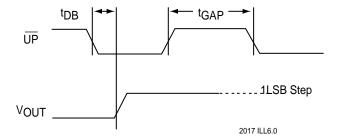


FIGURE 4. SLOW MODE TIMING

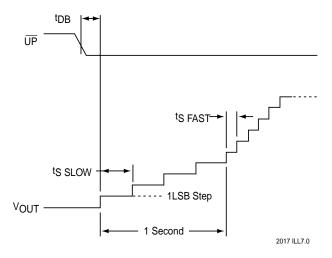
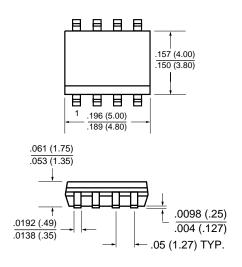


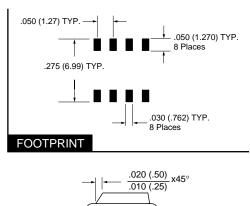
FIGURE 5. FAST MODE TIMING

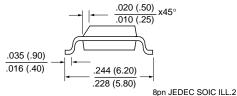
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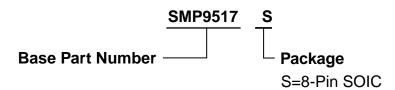
#### 8 Pin SOIC (Type S) Package JEDEC (150 mil body width)







#### ORDERING INFORMATION



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